

# XENPAK

## EXP85X-4SCD03

### XENPAK-10GBASE-SR 850nm, 300m Reach

- Compatible with XENPAK MSA Rev.3.0
- Support of IEEE802.3ae up to 300m (OM3 MMF)
- Power Consumption 1.8W (typ.)
- Temperature Range 0 to 70°C
- Vertical Cavity Surface Emitting Laser at 850nm (VCSEL)
- Adaptable Power Supply (APS:+1.2V)
- SC duplex connector
- Hot pluggable 70-pin connector with XAUI electrical interface
- Management and control via MDIO 2-wire interface
- Compatible with RoHS



## Reference

- 10GBASE SR 10G Ethernet

## Product Description

The XENPAK Module is a highly integrated, Serial optical transponder module for high-speed, 10Gbit/s data transmission applications. 4×3.125Gbps Ethernet Signal Input by XAUI Interface. An integrated Coder / Decoder and multiplexer / demultiplexer (SERDES: Serializer / Deserializer). Designing for 10GBASE-LR Transmission with a Vertical Cavity Surface Emitting Laser at 850nm. The transponder operates within a wide case temperature range of 0°C to +70° C and offers optimum heat dissipation and excellent electromagnetic shielding which enables high port densities for 10 GbE systems. A 70 pin electrical connector and a duplex SC connector optical interface assure that connectivity is compliant to the XENPAK MSA Rev.3.0.

## Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Ref.
Storage Ambient Temperature Range		-40	+85	°C	
Powered case Temperature Range		0	+70	°C	
Supply Voltage APS	Vaps	0	1.5	V	
Supply Voltage Range @ 3.3V	Vcc3	-0.5	4.0	V	

Any stress beyond the maximum ratings can result in permanent damage. The device specifications are guaranteed only under the recommended operating conditions.

## Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Unit
Operating Case Temperature	Tc	0		+70	°C
Power Supply Voltage	Vcc3	3.13	3.3	3.47	V
	Vaps	1.152	1.2	1.248	
Power Dissipation	PD			2.2	W

## Electrical DC Characteridtics

(VCC3=3.14V to 3.47V, VCCaps=1.152V to 1.248V, Tc=0 to 70

Parameter	Symbol	min.	typ.	max.	Unit
1.2V CMOS(1.8V CMOS Compatible1)I/O DC Characteristics (PRTAD;LASI;RESET;TX_ONOFF					
Output High Voltage	Voh	1			V
Output Low Voltage	Vol			0.15	V
Input High Voltage	Vih	0.84		1.5	V
Input Low Voltage	Vil			0.36	V
Input Pull-down Current	Ipd	20		120	uA
XAUI I/O DC Characteristics (TXLANE[0..3]; RXLANE[0..3])					
Differential Input Amplitude (pk-pk) 4)		220		1600	mV
Differential Output Amplitude (pk-pk) 4)		800		1600	
MDIO I/O DC Characteristics (MDIO; MDC)					
Output Low Voltage	VOL	-0.3		0.2	V
Output Low Current	IOL			20	mA
Input High Voltage	VIH	0.84		1.5	V
Input Low Voltage	VIL	-0.3		0.36	V

- 1) For 1.8 V CMOS Voh = 1.65 V min., Vol = 0.15 V max., Vih = 1.17 V min., Vil = 0.63 V max.
- 2) Rpull-up = 10 kΩ to 1.8 V.
- 3) Vin = 1.8 V.
- 4) AC coupled

## Electrical AC Characteridtics

(VCC3 = 3.14 V to 3.47 V, VCC aps = 1.152 V to 1.248 V, TC = 0°C to 70°C)

Parameter	Symbol	min.	typ.	max.	Unit
<b>XAUI Input AC Characteristics (TXLANE[0..3])</b>					
XAUI Baud Rate	DRin		3.125		Gbit/s
Differential Input Impedance	ZIN	80	100	120	Ω
<b>XAUI Output AC Characteristics (RXLANE[0..3])</b>					
XAUI Baud Rate	DRout		3.125		Gbit/s
XAUI Eye Mask (far-end)	According to IEEE 802.3ae				
Output Differential Impedance	ZO	80	100	120	Ω
Total Jitter <sup>4)</sup>	TJXAUI			0.35	UI
Deterministic Jitter <sup>4)</sup>	DJXAUI			0.37	UI
<b>Power-On Reset AC Characteristics</b>					
Power-On Reset AC Characteristics	According to XENPAK MSA Issue 3.0, 2002-9-18				

### MDIO I/O AC Characteristics (MDIO; MDC)

Parameter	Symbol	Value	Units
MDIO Data Hold Time	$t_{\text{HOLD}}$	10	ns
MDIO Data Setup Time	$t_{\text{SU}}$	10	ns
Delay from MDC Rising Edge to MDIO Data Change	$t_{\text{DELAY}}$	300	ns
MDC Clock Rate	$f_{\text{MAX}}$	2.5	MHz

- 1) 100 MHz to 2.5 GHz
- 2) At crossing point
- 3) Per IEEE Std 802.3ae
- 4) At near-end, No pre-equalization, 1 UI = 320 ps.

## Optical Interface Operating Conditions

Parameter	Fiber Type	Modal Bandwidth(MHz*km)	Symbol	Max.	Units
Operating range	62.5 $\mu\text{m}$ MMF	160	Lop	26	m
	50 $\mu\text{m}$ MMF	400		66	
	50 $\mu\text{m}$ MMF	500		82	
	50 $\mu\text{m}$ MMF	2000		300	

## Optical Characteristics

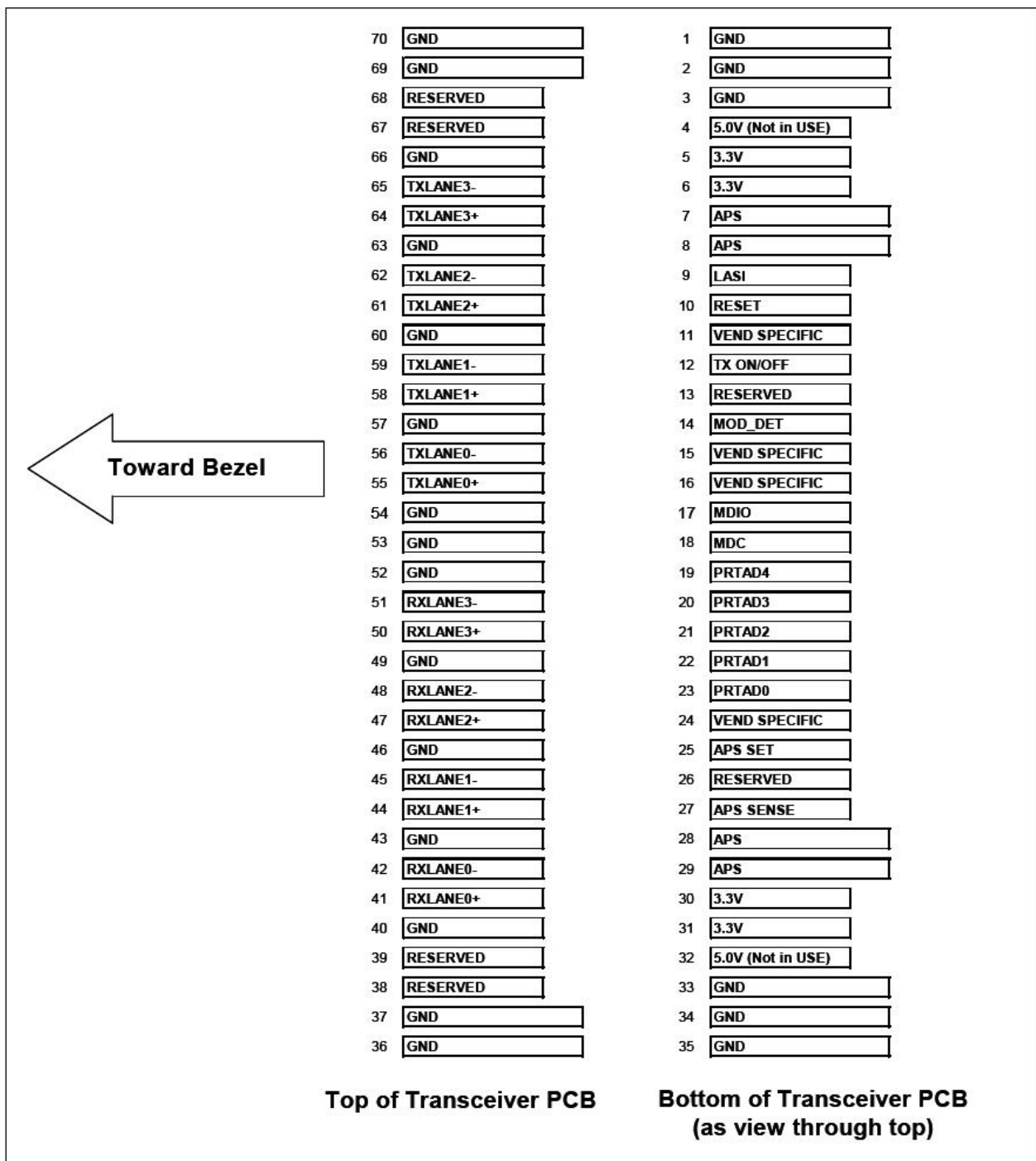
(VCC3 = 3.14 V to 3.47 V, VCC aps = 1.152 V to 1.248 V, TC = 0°C to 70°C, BER1E-12, Bit Rate 10.3125)

Parameter	Symbol	min.	typ.	max.	Unit
<b>Transmitter</b>					
Average Launch Power	PAvg	-5		-1	dBm
Transmitter and Dispersion Penalty	TDP			3.9	dB
Center Wavelength Range1)	$\lambda$	840	850	860	nm
RMS Spectral Width1)	$\Delta \lambda$		0.4	0.45	nm
Extinction Ratio	ER	3.0			dB
Relative Intensity Noise <sup>12</sup> OMA	RIN			-128	dB/Hz
Eye Mask Definition	According to IEEE 802.3ae				
Optical Return Loss Tolerance	ORLT			12	dB
Average Launch Power of OFF Transmitter	Poff			-30	dBm
<b>Receiver</b>					
Stressed Receiver Sensitivity in OMA	Pssen			-7.5	dBm
Receiver Sensitivity in OMA <sup>2)</sup>	Psen			-10.1	dBm
Power Overload	Po			-1	dBm







































































Signal Detect Deassert Level	Psa			-14.0	dBm
Signal Detect Assert Level	PSD	-18			dBm
Signal Detect Hysteresis	PSD	0.5	1.5		dB
Center Wavelength Range	$\lambda$	840		860	nm

- 1) Conforms to IEEE triple trade-off between center wavelength, RMS spectral width and minimum OMA.
- 2) Receiver sensitivity, which is defined for an ideal input signal is informative only.

## Electrical PAD Layout



## Host PCB XENPAK PINOUT

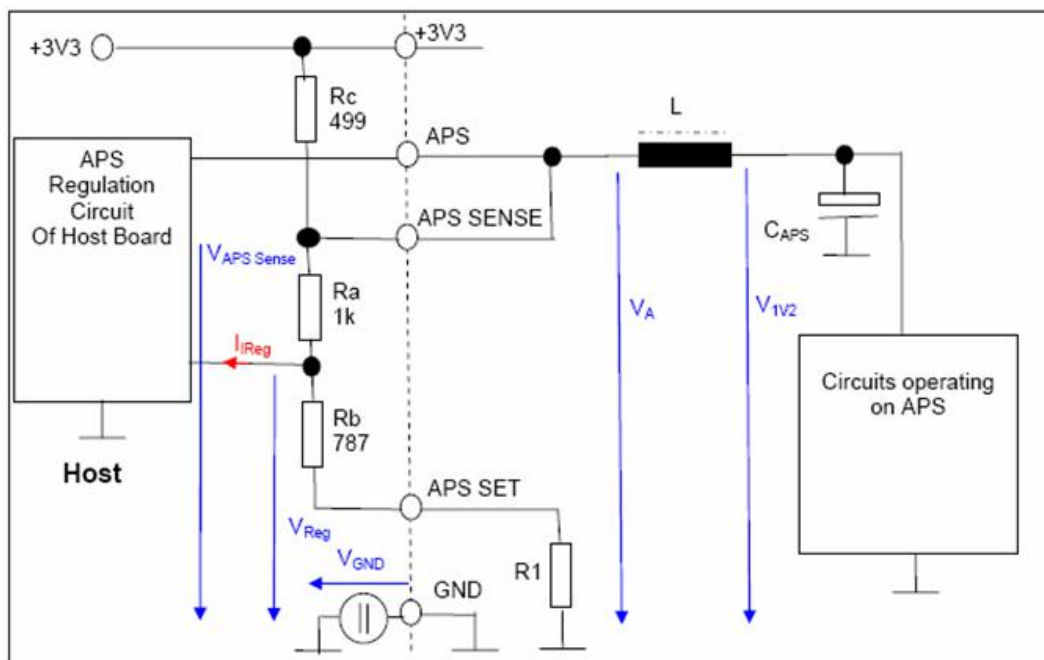
1	 GND	GND 	70
2	 GND	GND 	69
3	 GND	RESERVED 	68
4	 5.0V (Not in USE)	RESERVED 	67
5	 3.3V	GND 	66
6	 3.3V	TXLANE3- 	65
7	 APS	TXLANE3+ 	64
8	 APS	GND 	63
9	 LASI	TXLANE2- 	62
10	 RESET	TXLANE2+ 	61
11	 VEND SPECIFIC	GND 	60
12	 TX ON/OFF	TXLANE1- 	59
13	 RESERVED	TXLANE1+ 	58
14	 MOD_DET	GND 	57
15	 VEND SPECIFIC	TXLANE0- 	56
16	 VEND SPECIFIC	TXLANE0+ 	55
17	 MDIO	GND 	54
18	 MDC	GND 	53
19	 PRTAD4	GND 	52
20	 PRTAD3	RXLANE3- 	51
21	 PRTAD2	RXLANE3+ 	50
22	 PRTAD1	GND 	49
23	 PRTAD0	RXLANE2- 	48
24	 VEND SPECIFIC	RXLANE2+ 	47
25	 APS SET	GND 	46
26	 RESERVED	RXLANE1- 	45
27	 APS SENSE	RXLANE1+ 	44
28	 APS	GND 	43
29	 APS	RXLANE0- 	42
30	 3.3V	RXLANE0+ 	41
31	 3.3V	GND 	40
32	 5.0V (Not in USE)	RESERVED 	39
33	 GND	RESERVED 	38
34	 GND	GND 	37
35	 GND	GND 	36

## Pin Descriptions

Signal Name	Level	I/O	Pin NO.	Description
GND			1,2,3,33,34,35,36,37, 40,43,46,49,52,53,54, 57,60,63,66,69,70	Ground connection for signal ground on the module
APS	+1.2V		7,8,28,29	Input from Adaptive Power Supply
APS SENSE	+1.2V		27	APS Sense Output. Connected to the APS Sense Output. Connected to the APS input from APS
APS SET			25	Feedback input from APS. Connected to GND through a 1.18Kohm resistor inside the transponder.
3.3V	+3.3 V DC		5,6,30,31	DC Power Input, +5.0 V DC, Nominal
Reserved			25	Reserved for APD
Reserved			13	Reserved
MDIO	Open Drain	I/O	17	Management Data I/O. Requires external 10-22K $\Omega$ pull-up to the APS on host
MDC	1.2V CMOS	I	18	Management Data Clock Input
PRTAD4	1.2V CMOS	I	19	Port Address Input bit 4
PRTAD3	1.2V CMOS	I	20	Port Address Input bit 3
PRTAD2	1.2V CMOS	I	21	Port Address Input bit 2
PRTAD1	1.2V CMOS	I	22	Port Address Input bit 1
PRTAD0	1.2V CMOS	I	23	Port Address Input bit 0
LASI	Open Drain	O	9	Link Alarm Status Interrupt Output. Open Drain Compatible Output with 10 - 20 k $\Omega$ pull-up on host. Logic high = Normal Operation Logic low = Status Flag Triggered
RESET	Open Drain	I	10	Reset Input. Open Drain Compatible Input with 22 k $\Omega$ pull-up to APS internal to transponder. Logic high = Normal Operation Logic low = RESET
Vendor Specific			11,15,16,24	Vendor Specific Pins. Leave unconnected when not used.
TX ON/OFF	Open Drain	I	12	TX ON/OFF Input. Open Drain Compatible Input with 22 k $\Omega$ pull-up to APS internal to transponder. Logic high = Transmitter On Logic low = Transmitter Off

MOD DETECT		O	14	Pulled low inside transponder through a 1 k $\Omega$ resistor to Ground
Reserved		I	67,68,38,39	Reserved For Future Use
TX LANE 3–		I	65	Module XAUI Input Lane 3–
TX LANE 3+		I	64	Module XAUI Input Lane 3+
TX LANE 2–		I	62	Module XAUI Input Lane 2–
TX LANE 2+		I	61	Module XAUI Input Lane 2+
TX LANE 1–		I	59	Module XAUI Input Lane 1–
TX LANE 1+		I	58	Module XAUI Input Lane 1+
TX LANE 0–		I	56	Module XAUI Input Lane 0–
TX LANE 0+		I	55	Module XAUI Input Lane 0+
RX LANE 0+		O	41	Module XAUI Output Lane 0+
RX LANE 0–		O	42	Module XAUI Output Lane 0–
RX LANE 1+		O	44	Module XAUI Output Lane 1+
RX LANE 1–		O	45	Module XAUI Output Lane 1–
RX LANE 2+		O	47	Module XAUI Output Lane 2+
RX LANE 2–		O	48	Module XAUI Output Lane 2–
RX LANE 3+		O	50	Module XAUI Output Lane 3+
RX LANE 3–		O	51	Module XAUI Output Lane 3–

## Block Diagram of Adapter Power Supply Circuit

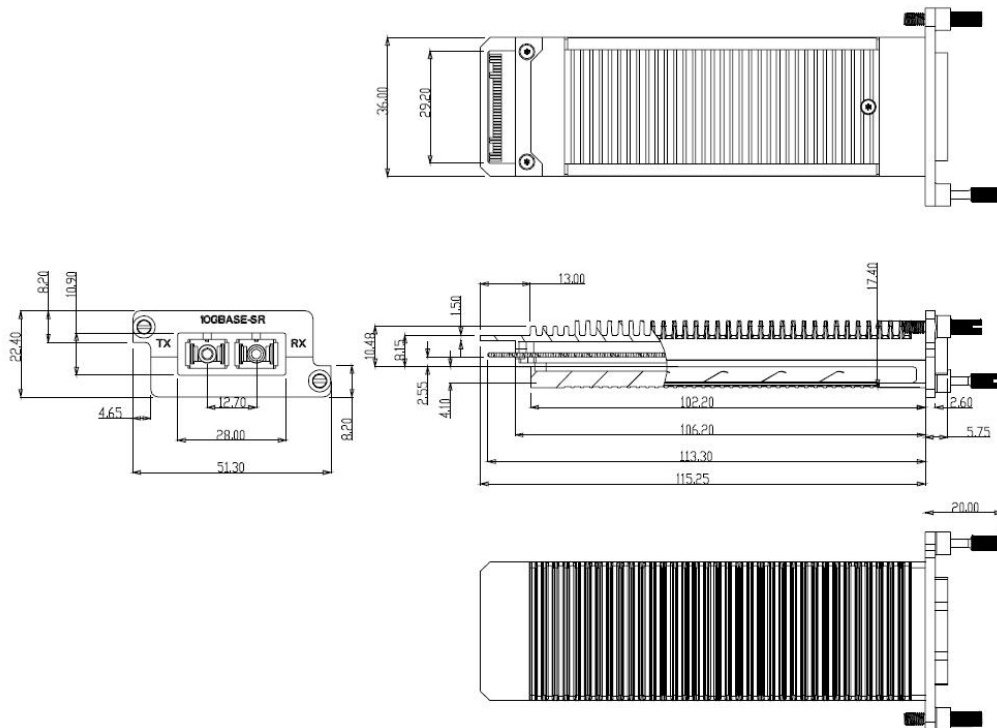




## Eye Safety

This laser based multimode transceiver is a Class 1 product. It complies with IEC 60825-1 Ed.2: 2007 and FDA performance standards for laser products (21 CFR 1040.10 and 1040.11) except for deviations pursuant to Laser Notice 50, dated June 24, 2007.

## Package Outline



## Compatibility Test

Part Number	Product Description
EXP85X-4SCD03	850nm, 10.3125Gbps, 300m(OM3 MMF), 0°C ~ +70°C

## Compatibility Test

In order to ensure the product compatibility, our products will be tested on the switch before shipment. Our modules can be compatible with many mainstream brand switches, such as Cisco, Juniper, Extreme, Brocade, IBM, H3C, HP, Huawei, D-Link, Mikrotik, ZTE, TP-Link...

Our test equipment: VOLKTEK MEN-4110, HP 2530-8G, CRS226-24G-25+RM, Catalyst 2960G Series, Catalyst 3850 XS 10G SFP+, Catalyst 3750-E Series, HUAWEI S5700Series, H3C S3100V2 Series, Juniper-EX4200, etc.



**Cisco Catalyst 3850**



**HUAWEI S5700**



**H3C S3100V2**



**HP J9264AR**



**Juniper EX 4200**



**Alcatel 6850E-U24X**



**Mikrotik CR5226-24G-25+RM**



**Cisco Catalyst 2960G**



**Volktek MEN-4110**

## Quality Assurance

Continuous introduction of new equipment, produced by strict standards, strict quality inspection, to guarantee the high quality standard of each product.



**Standardized  
Production Line**



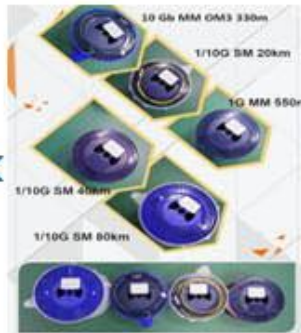
**Professional  
Welding**



**Assembling**



**Aging Testing**



**Distance Testing**



**Cleaning end face**



**Product Initial Test**



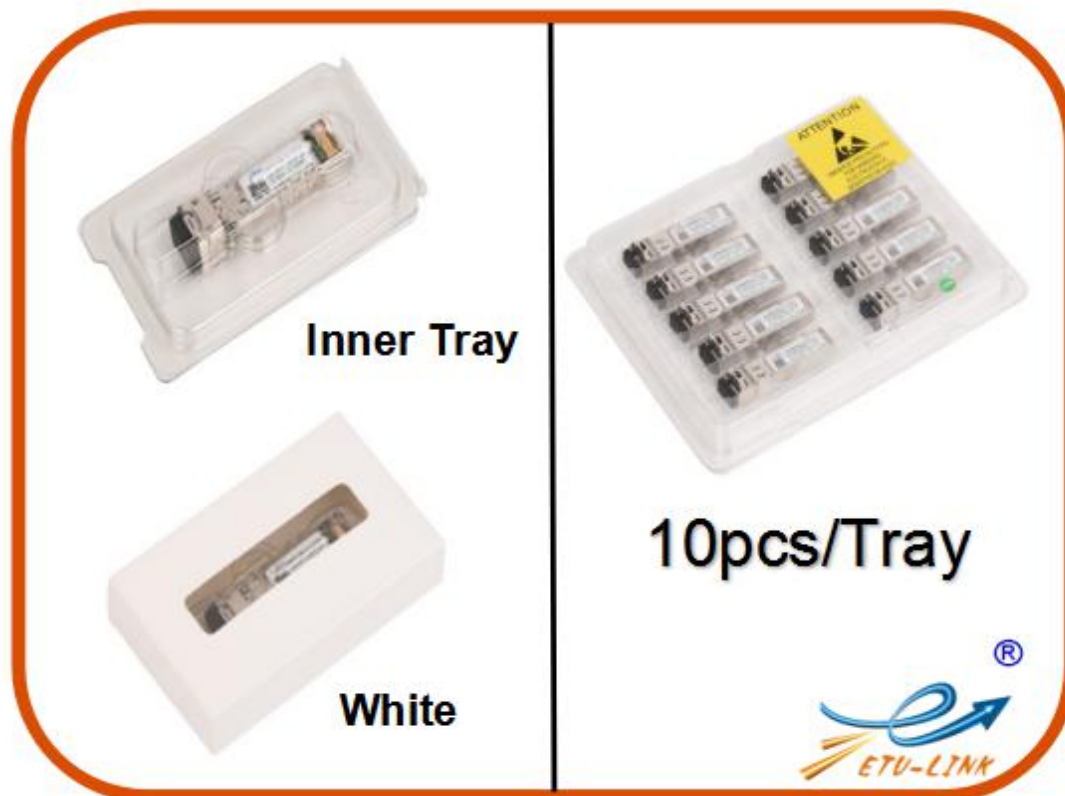
**Switch Testing**



**Product Final Test**

## Packaging

ETU-Link provides two kinds of packaging, 10pcs/Tray and individual package.



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Dalang street, Longhua District, Shenzhen city, Guangdong Province, China 518109

Tel: +86-755 2328 4603

Addresses and phone number also have been listed at [www.etulinktechnology.com](http://www.etulinktechnology.com).

Please e-mail us at [sales@etulinktechnology.com](mailto:sales@etulinktechnology.com) or call us for assistance.